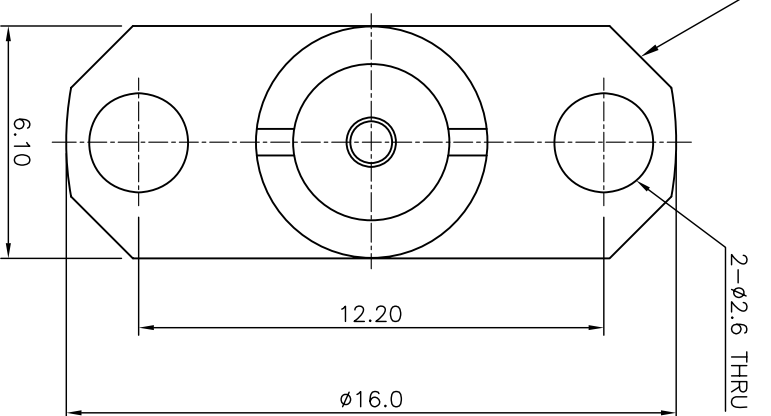
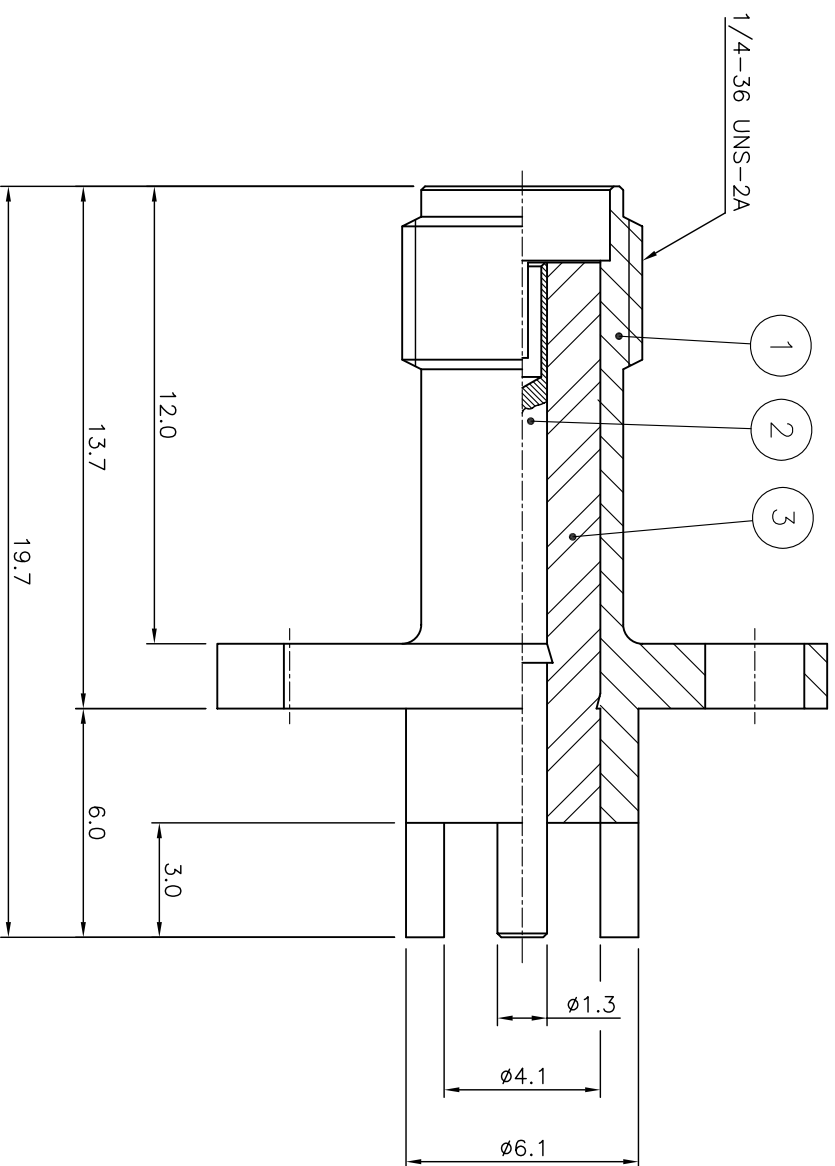


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1	Initial Registration	E.H.KIM	I.C.KIM	2013.01.16.



3	INSULATOR	1	TEFLON		DIN02123-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT02749-5/1
1	BODY	1	MBSBD	Nickel Plate	DBD03242-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

DATE 2013. 01. 16.

APPROVED BY I.C.KIM

CHECKED BY

DRAWN BY E.H.KIM

SCALE 5/1 UNIT mm

KJ COMTECH
RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE SMA50 SOLDER END JS-2H-2R

DWG NO. CN02926-7/1
REVISION 1 SHEET 1 of 1